REVISIONS																			
LTR				[	DESCR	IDITAI	N					DA	DATE (YR-MO-DA) APPROVED			ROVED			
В	Changes IA	Changes IAW NOR 5962-R087-93. – tjr						93-0	)2-25		Mon	ica L. F	oelking	]					
С	Add case o	utline Z.	. Updat	e boile	erplate	to MIL-	PRF-3	8535 re	equirem	nents	- jak	01-08-27 Thomas M. Hess							
D	Update boil	erplate	to MIL-F	PRF-3	8535 re	equiren	nents	LTG					08-0	)4-16		Thor	nas M.	Hess	
Current C	AGE CO	DE is	s 6720	68															
	I I	<u>т т</u>						1	1					1					1
REV																			
SHEET																			
SHEET																			
REV STATUS		1	REV			D	D	D	D	D	D	D	D	D	D	D	D		
OF SHEETS			SHEE	ΞT		1	2	3	4	5	6	7	8	9	10	11	12		
PMIC N/A			PREP	ARED	) BY	1	1	1		1	1	1	1	1	1	1	1	1	
					Greg	A. Pitz													
STA			CHEC	KED	BY				-	וט	CC	SE SI	BUS		D 432	218-39	-01VIB 990	03	
MICRO				Da	aniel A.	DiCen	ZO					http	)://ww	/w.ds	cc.dl	a.mil			
2.0		-	APPF	ROVE	D BY														
THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS		BLE		N	lelson /	A. Haud	ck		MIC OC	ROC		JIT, [ FER/L	DIGIT LINE	DRIV	ADVA /ER V	ANCE VITH	D CN	MOS, EE-	
		E	DRAV	VING /	APPRO	OVAL C	ATE		ST/	4ΙΕ (	JUIF	UIS	, MO	NOL	ITHIC	SIL	ICON		
DEPAR IMENT OF DEFENSE					87-0	5-12													
AMS	SC N/A		REVIS	SION I	LEVEL				SI	ZE	CA	GE CC	DE		ļ	5962-	-8755	51	
					[	J			SHF	۹ ET	14933 5902-07551								
					1 OF 12														

1.	SCOPE
	300F L

1.1 <u>Scope</u>. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



# 1.4 Recommended operating conditions.

+3.0 V dc to +5.5 V dc 1/
0.0 V dc to V <sub>cc</sub>
0.0 V dc to V <sub>CC</sub>
-55°C to +125°C
0 to 8 ns/V
0 to 8 ns/V
0 to 8 ns/V
0 to 5 ns/V

## 2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883	-	Test Method Standard Microcircuits.
MIL-STD-1835	-	Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings. MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at http://assist.daps.dla.mil/quicksearch/ or http://assist.daps.dla.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

<u>1</u>/ Operation from 2.0 V dc to 3.0 V dc is provided for compatibility with data retention and battery backup systems. Data retention implies no input transitions and no stored data loss with the following conditions:  $V_{IH} \ge 70\% V_{CC}$ ,  $V_{IL} \le 30\% V_{CC}$ ,  $V_{OH} \ge 70\% V_{CC}$  @ -20  $\mu$ A,  $V_{OL} \le 30\% V_{CC}$  @ 20  $\mu$ A.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-87551
DEFENSE SUPPLY CENTER COLUMBUS		REVISION LEVEL	SHEET
COLUMBUS, OHIO 43218-3990		D	3

#### 3. REQUIREMENTS

3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.

3.2.3 <u>Truth table</u>. The truth table shall be as specified on figure 2.

3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.

3.2.5 Switching waveforms and test circuit. The switching waveforms and test circuit shall be as specified on figure 4.

3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 <u>Marking</u>. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.5.1 <u>Certification/compliance mark</u>. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DSCC-VA shall be required for any change that affects this drawing.

3.9 <u>Verification and review</u>. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-87551
DEFENSE SUPPLY CENTER COLUMBUS		REVISION LEVEL	SHEET
COLUMBUS, OHIO 43218-3990		D	4

		TABLE I. Electrical per	tormance characte	eristics.			
Test	Symbol	Test con -55°C ≤ T <sub>C</sub> : unless otherwi	Group A subgroups	Lir	Limits		
			·		Min	Max	
High-level output	V <sub>OH</sub>	$V_{IN} = V_{IH}$ minimum	$V_{\rm CC} = 3.0$	0 V 1, 2, 3	2.9		V
voltage	1/	or $V_{IL}$ maximum	$V_{\rm CC} = 4.5$	5 V	4.4		
			V <sub>CC</sub> = 5.	5 V	5.4		
		$V_{IN} = V_{IH}$ minimum or $V_{IL}$ maximum $I_{OU} = -4.0$ mA	$V_{\rm CC} = 3.0$	0 V	2.4		
		$V_{IN} = V_{IH}$ minimum	$V_{CC} = 4.5$	5 V	3.7		
		or V <sub>IL</sub> maximum	$V_{cc} = 5.5$	5 V	4.7		-
		$V_{IN} = V_{IH}$ minimum or $V_{IL}$ maximum $L_{OU} = -50$ mA	$V_{\rm CC} = 5.8$	5 V	3.85		
Low-level output	V <sub>OL</sub>	$V_{IN} = V_{IH}$ minimum	$V_{cc} = 3$	0V 123		0.1	V
voltage	1/	or V <sub>IL</sub> maximum	$V_{CC} = 4.5$	5 V		0.1	
	<u>1</u> /	I <sub>OH</sub> = 50 μA	$V_{CC} = 5.5$	5 V		0.1	
		$V_{IN} = V_{IH}$ minimum or $V_{IL}$ maximum $I_{OH} = 12$ mA	$V_{\rm CC} = 3.0$	0 V		0.5	
		$V_{IN} = V_{IH}$ minimum	$V_{\rm CC} = 4.5$	5 V		0.5	
		or V <sub>IL</sub> maximum	$V_{CC} = 5.5$	5 V		0.5	
		$V_{IN} = V_{IH}$ minimum or $V_{IL}$ maximum	$V_{\rm CC} = 5.8$	5 V		1.65	
High-level input	V <sub>IH</sub>		V <sub>CC</sub> = 3.0	0 V 1, 2, 3	2.1		V
voltage	2/		$V_{\rm CC} = 4.5$	5 V 1, 2, 3	3.15		
	<u> </u>		V <sub>CC</sub> = 5.5	5 V 1, 2, 3	3.85		
Low-level input	V <sub>IL</sub>		$V_{\rm CC} = 3.0$	0 V 1, 2, 3		0.9	V
voltage	2/		$V_{\rm CC} = 4.5$	5 V 1, 2, 3		1.35	
	=		V <sub>CC</sub> = 5.	5 V 1, 2, 3		1.65	
Input leakage	IIL	V <sub>IN</sub> = 0.0 V	V <sub>CC</sub> = 5.5	5 V 1, 2, 3		-1.0	μΑ
	I <sub>IH</sub>	V <sub>IN</sub> = 5.5 V				1.0	
Quiescent current	I <sub>CCH</sub>	$V_{IN} = V_{CC}$ or GND		1, 2, 3		160	μA
		V <sub>CC</sub> = 5.5 V				160	-
Off-state output	ICCZ	V <sub>m</sub> – V <sub>m</sub> minimum or V <sub>m</sub> maximum				10.0	Δ
leakage current	I <sub>OZL</sub>	$V_{CC} = 5.5 V$ $V_{OUT} = V_{CC} \text{ or GND}$	$V_{IN} = V_{IH}$ minimum or $V_{IL}$ maximum $V_{CC} = 5.5 V$ $V_{OUT} = V_{CC}$ or GND			-10.0	μΛ
Input capacitance	C <sub>IN</sub>	See 4.3.1c		4		8.0	pF
Power dissipation capacitance	C <sub>PD</sub> <u>3</u> /	See 4.3.1c		4		60.0	pF
Functional tests		Tested at $V_{CC}$ = 4.5 V and re $V_{CC}$ = 5.5 V, see 4.3.1d	peated at	7, 8			
See footnotes at enc	d of table.						
MIODO	STAND	ARD	SIZE A			5962-87	7551
MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990				REVISION LEVEL D	SH		

Test	Symbol	Test con -55°C ≤ T <sub>C</sub> : unless otherwi	Group A subgroups	Limits		Unit	
					Min	Max	
Propagation delay	t <sub>PHL</sub>	C <sub>L</sub> = 50 pF	$V_{CC} = 3.0 V$	9	1.0	10.0	ns
time, mAn to mYn	4/	$R_{L} = 500\Omega$		10, 11	1.0	11.5	
		See figure 4	V <sub>CC</sub> = 4.5 V	9	1.0	8.0	
				10, 11	1.0	9.0	
	t <sub>PLH</sub>		V <sub>CC</sub> = 3.0 V	9	1.0	10.5	
	4/			10, 11	1.0	12.2	
			V <sub>CC</sub> = 4.5 V	9	1.0	8.5	
				10, 11	1.0	9.5	1
Output disable time,	t <sub>PHZ</sub>	C <sub>L</sub> = 50 pF	$V_{CC} = 3.0 V$	9	1.0	12.0	ns
OE1, OE2 to mYn	4/		10, 11	1.0	13.0		
			$V_{CC} = 4.5 V$	9	1.0	10.5	
				10, 11	1.0	11.5	
	t <sub>PLZ</sub>		$V_{CC} = 3.0 V$	9	1.0	12.0	
	4/			10, 11	1.0	13.0	
			$V_{CC} = 4.5 V$	9	1.0	10.5	
				10, 11	1.0	11.5	
Output enable time,	t <sub>PZH</sub>	C <sub>L</sub> = 50 pF	$V_{CC} = 3.0 V$	9	1.0	11.5	ns
OE1, OE2 to mYn	4/	$R_{L} = 500\Omega$		10, 11	1.0	13.8	
	t <sub>PZL</sub>	See ligule 4	$V_{CC} = 4.5 V$	9	1.0	9.0	
				10, 11	1.0	10.0	
			$V_{CC} = 3.0 V$	9	1.0	11.5	
	4/			10, 11	1.0	13.0	
			V <sub>CC</sub> = 4.5 V	9	1.0	9.0	
				10, 11	1.0	10.0	

# TABLE I. Electrical performance characteristics - Continued.

1/ V<sub>OH</sub> and V<sub>OL</sub> tests will be tested at V<sub>CC</sub> = 3.0 V and V<sub>CC</sub> = 4.5 V. V<sub>CC</sub> = 5.5 V tests are guaranteed, if not tested. Limits shown apply to operation at V<sub>CC</sub> = 3.3 V ±0.3 V and V<sub>CC</sub> = 5.0 V ±0.5 V. Transmission driving tests are performed at V<sub>CC</sub> = 5.5 V with a 2 ms duration maximum.

2/ The V<sub>IH</sub> and V<sub>IL</sub> tests are not required and shall be applied as forcing functions for the V<sub>OH</sub> and V<sub>OL</sub> tests.

 $\underline{3}$  Power dissipation capacitance (C<sub>PD</sub>), determines the dynamic power consumption.

 $P_D = (C_{PD} + C_L) V_{CC} 2 f + I_{CC} V_{CC}$ , and the dynamic current consumption (I<sub>S</sub>) is,  $I_S = (C_{PD} + C_L) V_{CC} f + I_{CC}$ .

 $\underline{4}$  AC limits at V<sub>CC</sub> = 5.5 V are equal to limits at V<sub>CC</sub> = 4.5 V and guaranteed by testing at V<sub>CC</sub> = 4.5 V. Minimum ac limits are guaranteed for V<sub>CC</sub> = 5.5 V by guardbanding V<sub>CC</sub> = 4.5 V limits to 1.5 ns (minimum).

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-87551
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990		REVISION LEVEL D	SHEET 6

Device types	01	(	)2
Case outlines	R, S, Z, and 2	L	3
Terminal number	Те	rminal symbol	
1	OE1	1Y1	NC
2	1A1	2Y1	V <sub>cc</sub>
3	4Y2	3Y1	4A1
4	2A1	4Y1	3A1
5	3Y2	GND	2A1
6	3A1	GND	1A1
7	2A2	GND	OE1
8	4A1	GND	NC
9	1Y2	1Y2	1Y1
10	GND	2Y2	2Y1
11	1A2	3Y2	3Y1
12	4Y1	4Y2	4Y1
13	2A2	OE2	GND
14	3Y1	4A2	GND
15	3A2	3A2	NC
16	2Y1	2A2	GND
17	4A2	1A2	GND
18	1Y1	V <sub>cc</sub>	1Y2
19	OE2	V <sub>cc</sub>	2Y2
20	V <sub>cc</sub>	4A1	3Y2
21		3A1	4Y2
22		2A1	NC
23		1A1	OE2
24		OE1	4A2
25			3A2
26			2A2
27			1A2
28			V <sub>CC</sub>

NC = No connection.

FIGURE 1. Terminal connections.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-87551
DEFENSE SUPPLY CENTER COLUMBUS		REVISION LEVEL	SHEET
COLUMBUS, OHIO 43218-3990		D	7

Device types 01 and 02

	Outputs		
OE1	OE2	mAn	mYn
L	н	L	L
L	н	Н	Н
Н	L	Х	Z





FIGURE 3. Logic diagram.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		5962-87551
		REVISION LEVEL D	SHEET 8





#### 4. VERIFICATION

4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
  - (2)  $T_A = +125^{\circ}C$ , minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

MIL-STD-883 test requirements	Subgroups
	(in accordance with
	MIL-STD-883, method 5005,
	table I)
Interim electrical parameters	
(method 5004)	
Final electrical test parameters	<u>1</u> / 1, 2, 3, 7, 8, 9
(method 5004)	
Group A test requirements	1, 2, 3, 4, 7, 8, 9, 10, 11
(method 5005)	
Groups C and D end-point	1, 2, 3
electrical parameters	
(method 5005)	
· · ·	

TABLE II. Electrical test requirements.

<u>1</u>/ PDA applies to subgroup 1.

4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

#### 4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C<sub>IN</sub> and C<sub>PD</sub> measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance. Test all applicable pins on 5 devices with zero failures.
- d. Subgroups 7 and 8 shall include verification of the truth table as specified on figure 2 herein.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		5962-87551
		REVISION LEVEL D	SHEET 11

# 4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
  - (2)  $T_A = +125^{\circ}C$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

# 5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractorprepared specification or drawing.

6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 <u>Record of users</u>. Military and industrial users should inform Defense Supply Center Columbus (DSCC) when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0547.

6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		5962-87551
		REVISION LEVEL D	SHEET 12

#### STANDARD MICROCIRCUIT DRAWING BULLETIN

#### DATE: 08-04-16

Approved sources of supply for SMD 5962-87551 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DSCC maintains an online database of all current sources of supply at http://www.dscc.dla.mil/Programs/Smcr/.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-87551012A	0C7V7	54AC241LMQB
5962-8755101RA	0C7V7	54AC241DMQB
5962-8755101SA	0C7V7	54AC241FMQB
5962-8755101ZA	0C7V7	54AC241WG-QML
5962-87551023A	3V146	54AC11241/B3A
5962-8755102LA	3V146	54AC11241/BLA

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed, contact the vendor to determine its availability.
- <u>2</u>/ <u>Caution</u>. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number	Vendor name and address
0C7V7	QP Semiconductor 2945 Oakmead Village Court Santa Clara, CA 95051
3V146	Rochester Electronics 16 Malcolm Hoyt Drive

Newburyport, MA 01950

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Buffers & Line Drivers category:

Click to view products by E2v manufacturer:

Other Similar products are found below :

5962-9217601MSA 634810D 875140G HEF4022BP HEF4043BP NL17SG125DFT2G NL17SZ126P5T5G NLU1GT126CMUTCG NLU3G16AMX1TCG NLV27WZ125USG MC74HCT365ADTR2G BCM6306KMLG 54FCT240CTDB Le87401NQC Le87402MQC 028192B 042140C 051117G 070519XB 065312DB 091056E 098456D NL17SG07DFT2G NL17SG17DFT2G NL17SG34DFT2G NL17SZ07P5T5G NL17SZ125P5T5G NLU1GT126AMUTCG NLV27WZ16DFT2G 5962-8982101PA 5962-9052201PA 74LVC07ADR2G MC74VHC1G125DFT1G NL17SH17P5T5G NL17SZ125CMUTCG NLV17SZ07DFT2G NLV37WZ17USG NLVHCT244ADTR2G NC7WZ17FHX 74HCT126T14-13 NL17SH125P5T5G NLV14049UBDTR2G NLV37WZ07USG 74VHC541FT(BE) RHFAC244K1 74LVC1G17FW4-7 74LVC1G126FZ4-7 BCM6302KMLG 74LVC1G07FZ4-7 74LVC1G125FW4-7